Tyrone Camarero Specifications

Camerero: SDA200A3H-460

Kev Feature

- AMD EPYC[™] 9004 series Processors, Dual Socket SP5 supported, CPU TDP supports Up to 400W TDP
- Up to 6TB 3DS ECC RDIMM, DDR5-4800MHz in 24 DIMM slots
- Integrated IPMI 2.0 + KVM with dedicated LAN
- 32x SATA3 Hybrid via MCIO, 1 AIOM slot
- ASPEED AST2600 BMC graphics via I/O board
- 10 PCle 5.0 x8 MCIO connectors
- 4x USB 3.0 ports (2 rear via I/O board + 2 via header)
- "60 x 2.5""/3.5"" Top loading Bays (SAS/SATA) with 2 x 30 drive expander
- 12 x 2.5""/3.5"" Rear Bays (SAS/SATA/NVMe) with direct attached backplane"
- "2000W(80 Plus Titanium Redundant PSUs)







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AMD EPYC™ 9004 series Processors, Dual **Processor**

Socket SP5 supported, CPU TDP supports

Up to 400W TDP

Chipset

Chipset System On Chip

System Memory

Memory Capacity Up to 6TB 3DS ECC RDIMM, DDR5-4800MHz in 24 DIMM slots

Expansion Slot

PCI-Express

1 PCle 5.0 x16 Right Riser Slot,1 PCle 5.0 x16

Left Riser Slot

M.2 Interface: 2 PCle 3.0 x4

Integrated Onboard:

LAN 1 Dedicated IPMI LAN port

Add-on Options

Raid Card Optional

Optical Drive

None

Drive bays

HDD Bays "60 x 2.5""/3.5"" Top loading Bays

(SAS/SATA) with 2 x 30 drive expander

backplane

12 x 2.5""/3.5"" Rear Bays (SAS/SATA/NVMe) with direct

attached backplane"

Power Supply

2000W(80 Plus Titanium Redundant **Power Supply**

PSUs)

Form Factor

Form Factor 4U Rackmount

Dimensions

Dimensions 1046.4*446.2*175.7 (D x W x H)

1191.5*446.2*175.7 (D x W x H) (with

CMA)

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